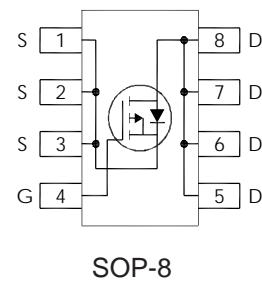


Applications

- Charge and Discharge Switch for Notebook PC
Battery Application



Features

- $V_{DS} (V) = -30V$
- $I_D = -16A$ ($V_{GS} = -10V$)
- $R_{DS(ON)} < 6.6m\Omega$ ($V_{GS}=-10V$)
- $R_{DS(ON)} < 10.2 m\Omega$ ($V_{GS}=-4.5V$)

Features

Industry-Standard SO8 Package	Resulting Benefits
RoHS Compliant Containing no Lead, no Bromide and no Halogen	Multi-Vendor Compatibility
	Environmentally Friendlier

Absolute Maximum Ratings

Parameter	Max.	Units
V_{DS} Drain-to-Source Voltage	-30	V
V Gate-to-Source Voltage	± 20	
I @ $T_A = 25^\circ C$ Continuous Drain Current, $V_{GS} @ 10V$	-16	
I @ $T_A = 70^\circ C$ Continuous Drain Current, $V_{GS} @ 10V$	-13	A
I Pulsed Drain Current ①	-130	
P @ $T_A = 25^\circ C$ Power Dissipation ④	2.5	W
P @ $T_A = 70^\circ C$ Power Dissipation ④	1.6	
Linear Derating Factor	0.02	W/ $^\circ C$
T Operating Junction and	-55 to + 150	$^\circ C$
T Storage Temperature Range		

Static @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
BV_{DSS}	Drain-to-Source Breakdown Voltage	-30			V	$V_{\text{GS}} = 0\text{V}, I_D = -250\mu\text{A}$
$\Delta \text{BV}_{\text{DSS}/\Delta T_J}$	Breakdown Voltage Temp. Coefficient		0.022		V/ $^\circ\text{C}$	Reference to $25^\circ\text{C}, I_D = -1\text{mA}$
$R_{\text{DS(on)}}$	Static Drain-to-Source On-Resistance		5.4	6.6	$\text{m}\Omega$	$V_{\text{GS}} = -10\text{V}, I_D = -16\text{A}$ ③
			8.3	10.2		$V_{\text{GS}} = -4.5\text{V}, I_D = -13\text{A}$ ③
$V_{\text{GS(th)}}$	Gate Threshold Voltage	-1.3	-1.8	-2.4	V	$V_{\text{DS}} = V_{\text{GS}}, I_D = -50\mu\text{A}$
$\Delta V_{\text{GS(th)}}$	Gate Threshold Voltage Coefficient		-5.7		mV/ $^\circ\text{C}$	
I_{DSS}	Drain-to-Source Leakage Current			-1.0	μA	$V_{\text{DS}} = -24\text{V}, V_{\text{GS}} = 0\text{V}$
				-150		$V_{\text{DS}} = -24\text{V}, V_{\text{GS}} = 0\text{V}, T_J = 125^\circ\text{C}$
I_{GSS}	Gate-to-Source Forward Leakage			-100	nA	$V_{\text{GS}} = -20\text{V}$
	Gate-to-Source Reverse Leakage			100		$V_{\text{GS}} = 20\text{V}$
g_{fs}	Forward Transconductance	36			S	$V_{\text{DS}} = -10\text{V}, I_D = -13\text{A}$
Q_g	Total Gate Charge ⑥		31		nC	$V_{\text{DS}} = -15\text{V}, V_{\text{GS}} = -4.5\text{V}, I_D = -13\text{A}$
Q_g	Total Gate Charge ⑥		61	92		$V_{\text{GS}} = -10\text{V}$
Q_{qs}	Gate-to-Source Charge ⑥		9		nC	$V_{\text{DS}} = -15\text{V}$
Q_{qd}	Gate-to-Drain Charge ⑥		14			$I_D = -13\text{A}$
R_G	Gate Resistance ⑥		14		Ω	
$t_{\text{d(on)}}$	Turn-On Delay Time		19		ns	$V_{\text{DD}} = -15\text{V}, V_{\text{GS}} = -4.5\text{V}$ ③ $I_D = -1.0\text{A}$ $R_G = 6.8\Omega$ See Figs. 20a & 20b
t_r	Rise Time		64			
$t_{\text{d(off)}}$	Turn-Off Delay Time		160			
t_f	Fall Time		120			
C_{iss}	Input Capacitance		2820		pF	$V_{\text{GS}} = 0\text{V}$
C_{oss}	Output Capacitance		640			$V_{\text{DS}} = -15\text{V}$
C_{rss}	Reverse Transfer Capacitance		370			$f = 1.0\text{MHz}$

Avalanche Characteristics

	Parameter	Typ.	Max.	Units
E_{AS}	Single Pulse Avalanche Energy ②		330	mJ
I_{AR}	Avalanche Current ①		-13	A

Diode Characteristics

	Parameter	Min.	Typ.	Max.	Units	Conditions
I_s	Continuous Source Current (Body Diode)			-2.5	A	MOSFET symbol showing the integral reverse p-n junction diode.
I_{SM}	Pulsed Source Current (Body Diode) ①			-130		
V_{SD}	Diode Forward Voltage			-1.2	V	$T_J = 25^\circ\text{C}, I_S = -2.5\text{A}, V_{\text{GS}} = 0\text{V}$ ③
t_{rr}	Reverse Recovery Time		33	50	ns	$T_J = 25^\circ\text{C}, I_F = -2.5\text{A}, V_{\text{DD}} = -24\text{V}$ $dI/dt = 100\text{A}/\mu\text{s}$ ③
Q_{rr}	Reverse Recovery Charge		30	45	nC	

Thermal Resistance

	Parameter	Typ.	Max.	Units
R_{DjL}	Junction-to-Drain Lead ⑤		20	$^\circ\text{C/W}$
R_{DJA}	Junction-to-Ambient ④		50	

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Starting $T_J = 25^\circ\text{C}$, $L = 4.3\text{mH}$, $R_G = 25\Omega$, $I_{\text{AS}} = -13\text{A}$.
- ③ Pulse width $\leq 400\mu\text{s}$; duty cycle $\leq 2\%$.
- ④ When mounted on 1 inch square copper board.
- ⑤ R_θ is measured at T_J of approximately 90°C .

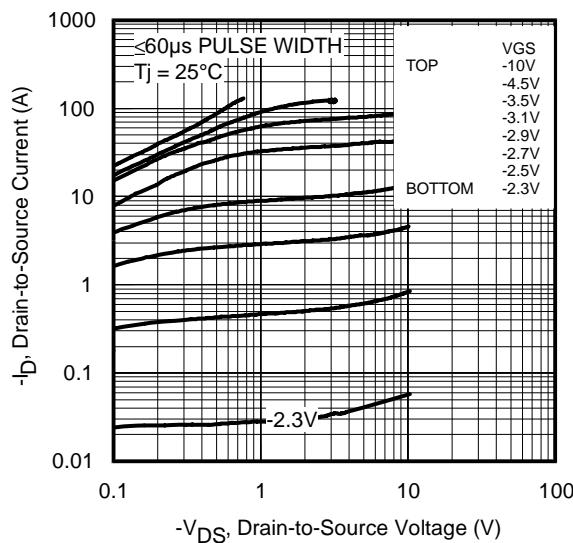


Fig 1. Typical Output Characteristics

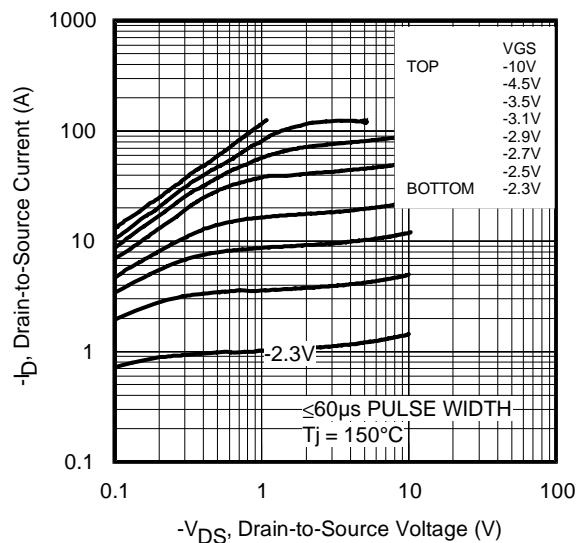


Fig 2. Typical Output Characteristics

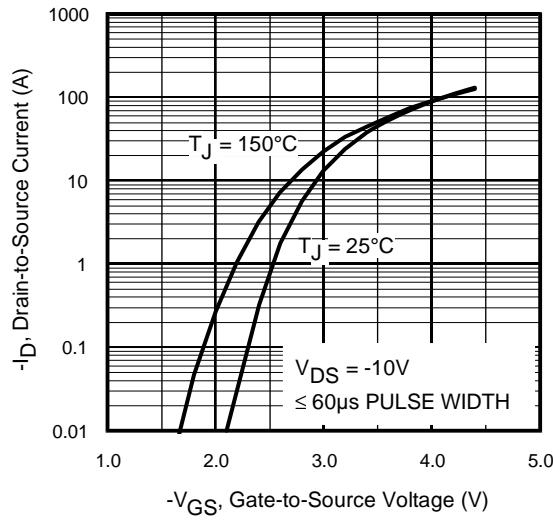


Fig 3. Typical Transfer Characteristics

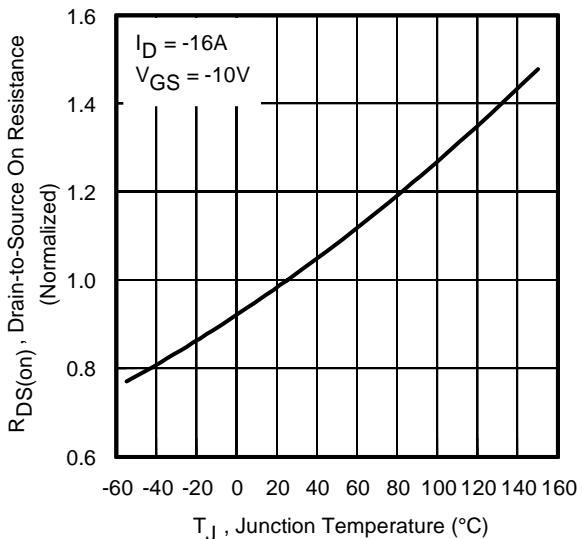


Fig 4. Normalized On-Resistance vs. Temperature

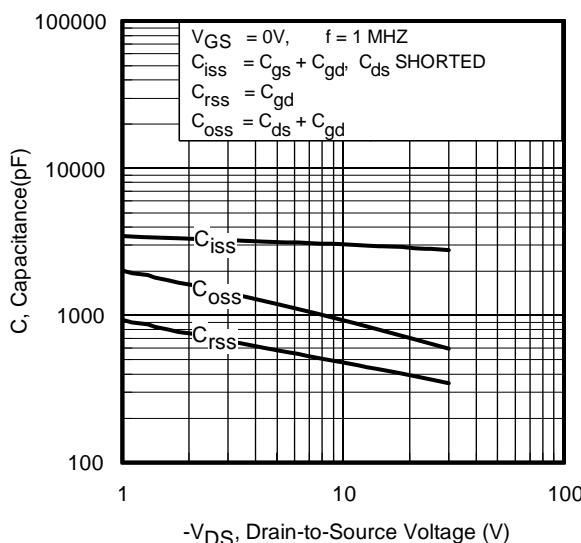


Fig 5. Typical Capacitance vs.Drain-to-Source Voltage

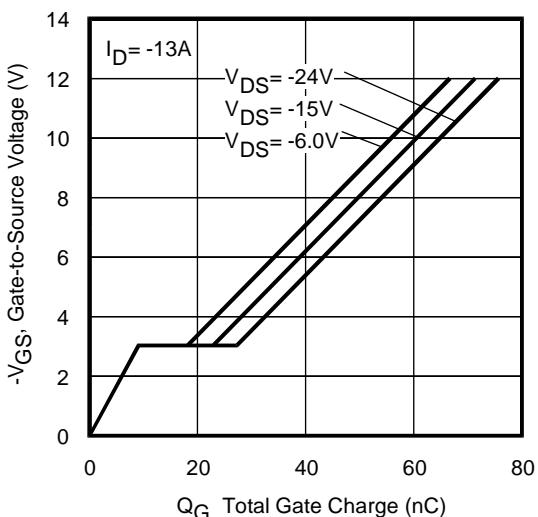


Fig 6. Typical Gate Charge vs.Gate-to-Source Voltage

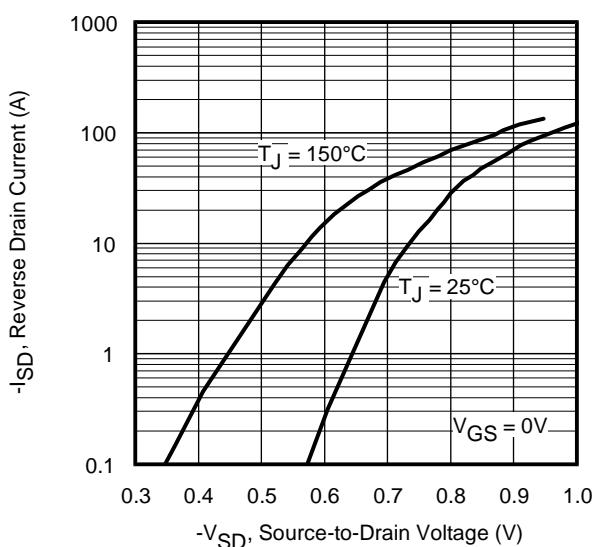


Fig 7. Typical Source-Drain Diode Forward Voltage

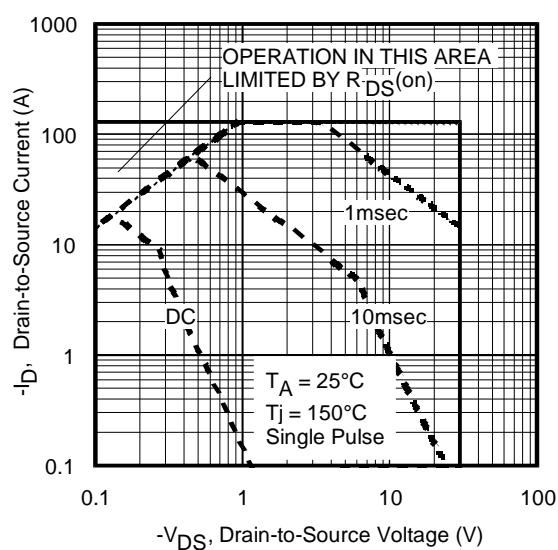


Fig 8. Maximum Safe Operating Area

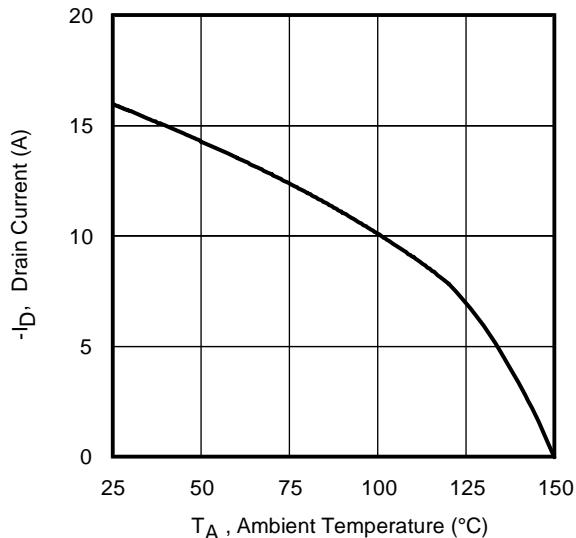


Fig 9. Maximum Drain Current vs. Ambient Temperature

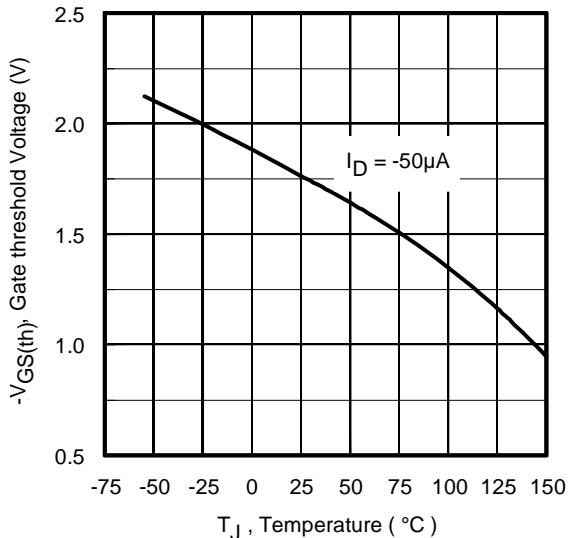


Fig 10. Threshold Voltage vs. Temperature

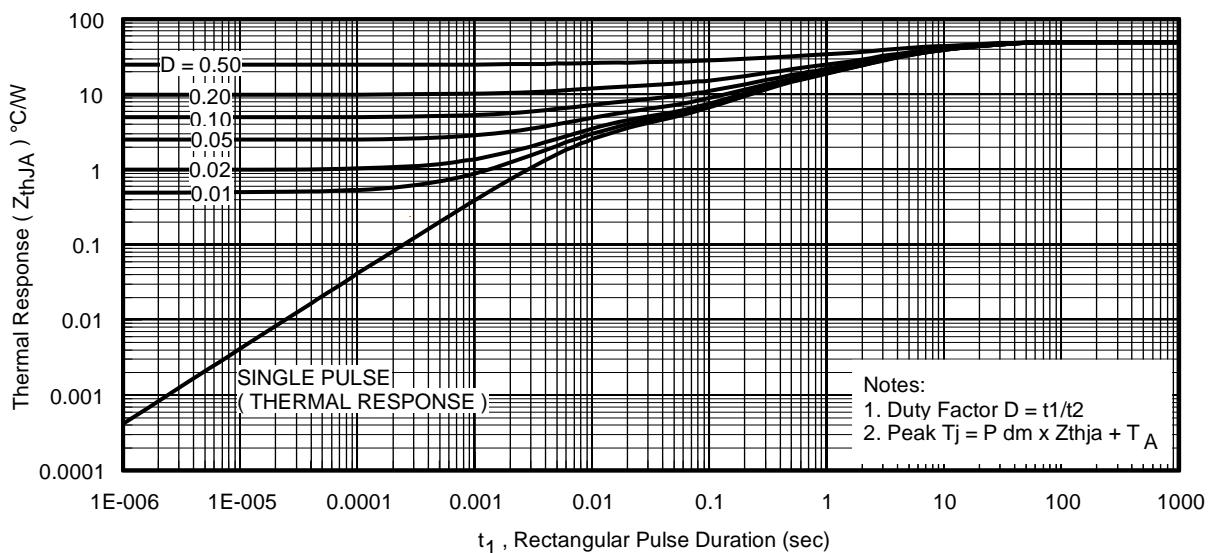


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

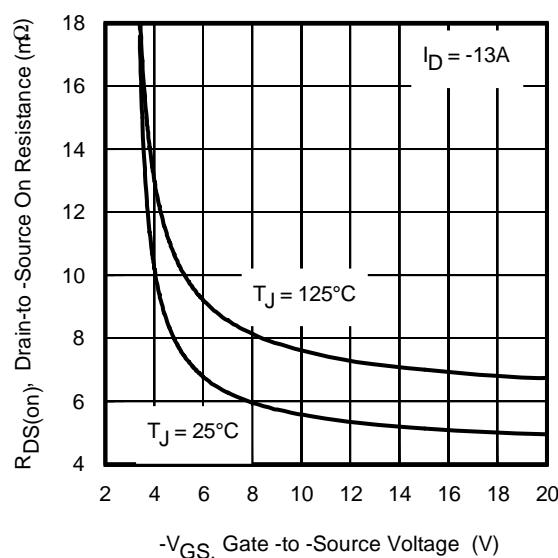


Fig 12. On-Resistance vs. Gate Voltage

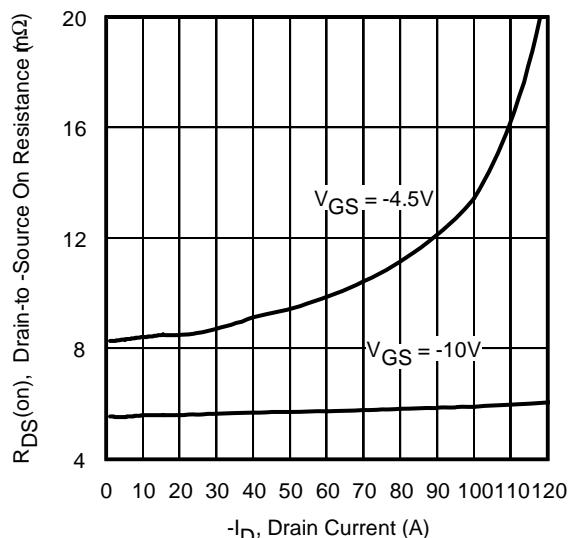


Fig 13. Typical On-Resistance vs. Drain Current

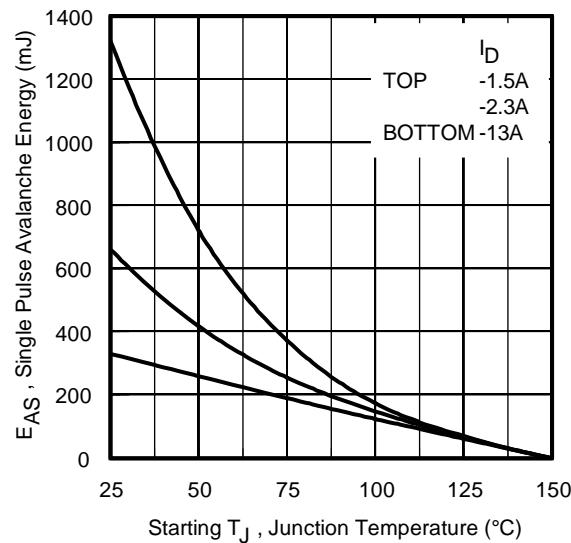


Fig 14. Maximum Avalanche Energy vs. Drain Current

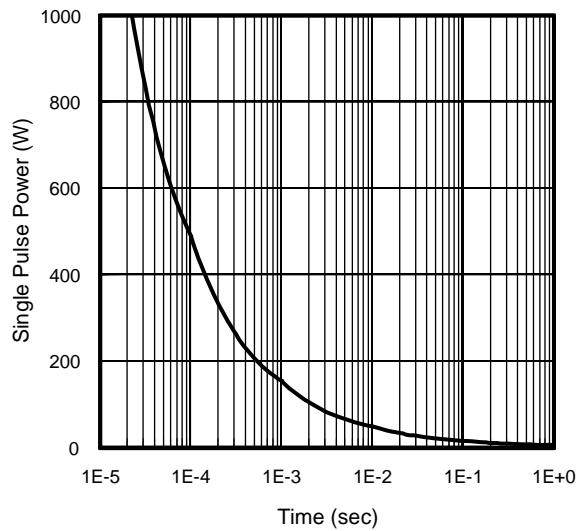


Fig 16. Typical Power vs. Time

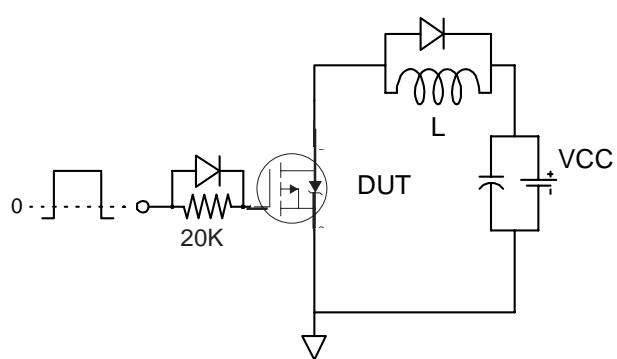


Fig 17a. Gate Charge Test Circuit

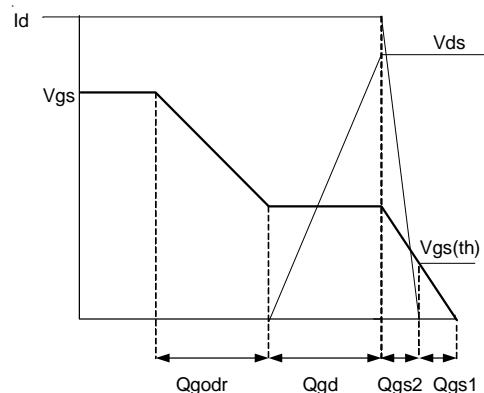


Fig 17b. Gate Charge Waveform

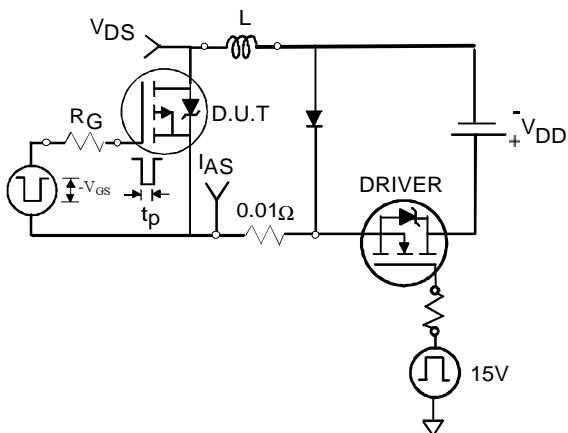


Fig 18a. Unclamped Inductive Test Circuit

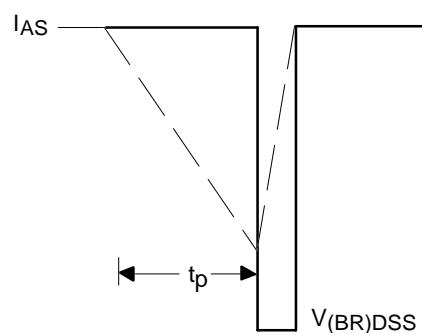


Fig 18b. Unclamped Inductive Waveforms

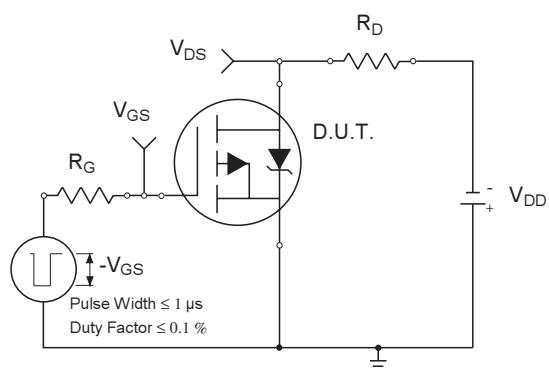


Fig 19a. Switching Time Test Circuit

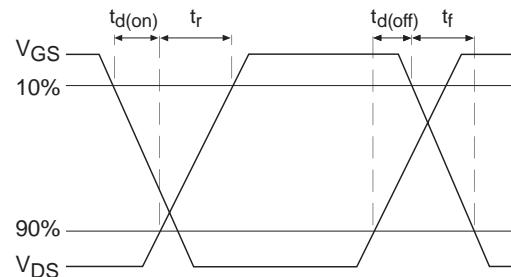
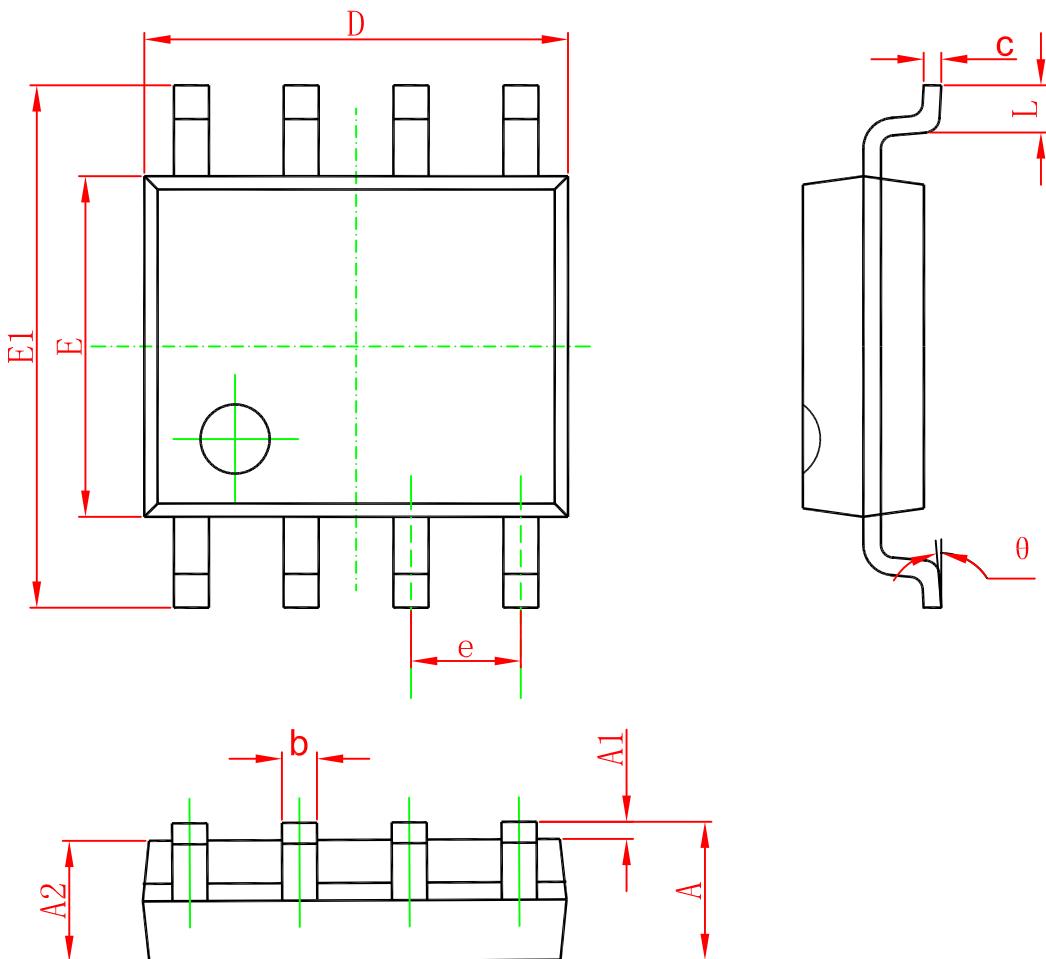


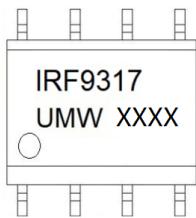
Fig 19b. Switching Time Waveforms

Package Mechanical Data SOP-8



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270(BSC)		0.050(BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

Marking



Ordering information

Order code	Package	Baseqty	Deliverymode
UMW IRF9317TR	SOP-8	3000	Tape and reel

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[DMN2990UFB-7B](#) [SSM3K35CT,L3F](#) [IPLK60R1K0PFD7ATMA1](#) [2N7002W-G](#) [MCAC30N06Y-TP](#) [IPWS65R035CFD7AXKSA1](#)
[MCQ7328-TP](#) [SSM3J143TU,LXHF](#) [PJMF280N65E1_T0_00201](#) [PJMF380N65E1_T0_00201](#) [PJMF280N60E1_T0_00201](#)
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